

## ABSTRACT

A semiconductor device which is appropriate for a microwave circuit and which is produced in a semiconductor substrate, the semiconductor device having surface wirings on the semiconductor substrate, the semiconductor substrate having rear wirings connected with the surface wirings by employing via hole wirings. A structure including a semiconductor device consisting of a semiconductor device which is appropriate for a microwave circuit and which is produced in a semiconductor substrate, the semiconductor device having surface wirings on the semiconductor substrate, the semiconductor substrate having rear wirings connected with the surface wirings by means of via hole wirings and a dielectric substrate having surface wirings thereon, the surface wirings being adhered to the rear wirings of the foregoing semiconductor device.

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